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January 5, 2005

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To: Examiner Renzo Rocchegiani
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Fax Number: 703/872-9306
Client Number: MIO 0109 PA
Pages: 6
(including cover)

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Comments: **OFFICIAL** **OFFICIAL** **OFFICIAL**

Applicant : Jingyi Bai et al.
Serial No. : 10/618,220
Filed : July 11, 2003
Title : METHODS FOR FILLING HIGH ASPECT RATIO
TRENCHES IN SEMICONDUCTOR LAYERS
Art Unit : 2825
Examiner : Renzo Rocchegiani

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JAN 05 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of

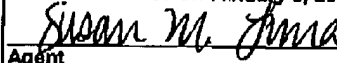
Applicant : Jingyi Bai et al.
Serial No. : 10/618,220
Filed : July 11, 2003
Title : METHODS FOR FILLING HIGH ASPECT RATIO TRENCHES IN
SEMICONDUCTOR LAYERS
Docket No. : MIO 0109 PA
Art Unit : 2825
Examiner : Renzo Rocchegiani

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

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Agent

Reg. No. 38,769


REQUEST FOR CONSIDERATION OF INFORMATION DISCLOSURE STATEMENT

In reviewing the Notice of Allowance mailed December 20, 2004 in this application, applicants noted that the Information Disclosure Statement filed on October 3, 2003 was not previously considered by the Examiner. Accordingly, applicants are submitting herewith a copy of the Information Disclosure Statement as filed along with a copy of the date-stamped return card received from the Patent Office. Applicants respectfully request entry and consideration of the Information Disclosure Statement.

Respectfully submitted,

DINSMORE & SHOHL LLP

By



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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of

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Applicants : Bai et al.
Serial No. : 10/619,220
Filed : July 11, 2003
Title : **METHODS FOR FILLING HIGH ASPECT RATIO TRENCHES IN SEMICONDUCTOR LAYERS**
Docket : MIO 0109 PA/40509.247/02-1541

JAN 05 2005

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF MAILING
I hereby certify that this correspondence is being deposited with the
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1450 on October 3, 2003.

Joan N. Williams
Joan N. Williams - Attorney Reg. No. 52,364

Sir:

INFORMATION DISCLOSURE STATEMENT
UNDER 37 CFR §§ 1.56, 1.97, AND 1.98

Applicants submit herewith patents, publications, and other information of which they are aware, which they believe may be material, as defined in 37 CFR §1.56(b), to the examination of this application and in respect of which there may be a duty to disclose in accordance with 37 CFR §1.56(a). While the information referred to in this Information Disclosure Statement may be material pursuant to 37 CFR §1.56(b), the filing of this Information Disclosure Statement is not intended to, pursuant to 37 CFR §1.97(h), constitute an admission that any patent, publication, or other information referred to is, or is considered to be, material to the patentability of this invention. Further, pursuant to 37 CFR §1.97(g), the filing of this Statement should not be construed as a statement that a search has been made or that no other material information exists.

This Information Disclosure Statement is being filed within the period set forth in 37 CFR §1.97(b) because it is filed within three months of the filing date of a national application or within three months of the date of entry of the national stage as set forth in 37 CFR §1.491 in an international application.

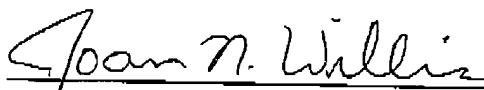
The Office has waived the requirement pursuant to 37 CFR 1.98 (a)(2)(i) for submitting a copy of each cited U.S. patent and each U.S. patent application publication for all

Serial No. 10/619,220

Docket No. MIO 0109 PA/40509.247/02-1541

U.S. national patent applications filed after June 30, 2003 and for all international applications that have entered the national stage under 35 USC § 371 after June 30, 2003. Therefore, no copies of each cited U.S. patent and each cited U.S. patent application publication are enclosed, but the cited U.S. patents and the cited U.S. patent application publications are listed on PTO/SB/08A.

Respectfully submitted,
DINSMORE & SHOHL LLP

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Application Number	10/619,220
Filing Date	July 11, 2003
First Named Inventor	Jingyi Bai
Art Unit	
Examiner Name	
Attorney Docket Number	MIO 0109 PA/40509.247/02-1541

Sheet	1	of	1
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This collection of information is required by 37 CFR 1.97 and 1.98. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.14. This collection is estimated to take 2 hours to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

PAGE 5/6 * RCVD AT 1/5/2005 3:23:50 PM [Eastern Standard Time] * SVR:USPTO-EFXRF-1/3 * DNIS:8729306 * CSID:9372230724 * DURATION (mm-ss):02-24

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Papers: Information Disclosure Statement (2 pgs.), PTO/SB/08a

Inventor(s): Bai et al.

Title: METHODS FOR FILLING HIGH ASPECT RATIO TRENCHES IN SEMICONDUCTOR LAYERS

Serial No.: 10/619,220

Docket No.: MIO 0109 PA/40509.24/02-1541

Date Due: 10/11/2003

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October 3, 2003

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